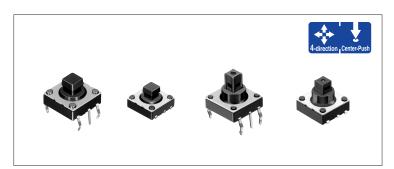
Multi Control Device TACT Switch™ 4-direction with Center-push Function (SMD & Snap-inType)

SKQU Series



10×10mm size with sharp click feeling.



Multi Control **Devices**

Product Line

4-directional Type

Product No.	Operating force		Travel (mm)		Rating	Rating	Operating life	Initial contact	Variety	Minimum order	Drawing
	4-direction	Center-push	4-direction	Center-push	(max.)	(min.)	(5mA 5V DC)	resistance	variety	unit (pcs.)	No.
SKQUAAA010	1.57N		0.35		50mA	10 <i>μ</i> Α	50,000cycles for each direction	500m Ω	Snap-in type	1,000	1
SKQUBAE010	1.5710		0.33		12V DC	1V DC		max.	Surface mount type	3,000	2

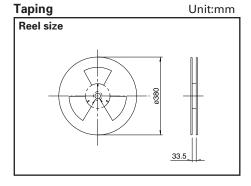
With Center-push Type

Product No.	Operating force		Travel (mm)		Rating	Rating	Operating life	Initial contact	Variety	Minimum order	Drawing
	4-direction	Center-push	4-direction	Center-push	(max.)	(max.)	(5mA 5V DC)	resistance	variety	unit (pcs.)	No.
SKQUCAA010	1.57N	3.14N	0.4	0.2	50mA	10 <i>μ</i> Α	100,000cycles for each direction	500m Ω max.	Snap-in type	1,000	3
SKQUDBE010	1.5710	3.1411	0.4	0.2	12V DC	1V DC			Surface mount type	2,400	4

Variable Resistor Type

Switch Type

Packing Specifications



Series	Number	of package	s (pcs.)	Tape width	Export package	
Series	1 reel	1 case /Japan	1 case /export packing	(mm)	measurements (mm)	
SKQUBA	750	3,000	3,000	32	401×401×214	
SKQUDB	600	2,400	2,400	32		

Bulk

Product No.	Number of pa	Export package measurements (mm)		
r roduct ivo.	1 case /Japan	1 case /Japan 1 case/export packing		
SKQUAA	4.000	12.000	309×476×347	
SKQUCA	4,000	12,000	309×4/6×34/	

- 1. For SKQUAA, and SKQUBA models, the 4-directional operating force and travel are measured 0.9mm below the top of the stem.
- 2. For SKQUCA models, the 4-directional operating force and travel are measured 2.9mm below the top of the stem.
- 3. For SKQUDB models, the 4-directional operating force and travel are measured 1.5mm below the top of the stem.
- 4. Please place purchase orders for taping products per minimum package units (1 reel or 1 case).

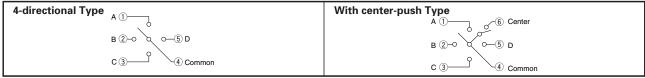
Dimensions (4-directional Type) Unit:mm PC board mounting hole dimensions Photo Style No. (Viewed from switch mounting face) Snap-in type Center of stem rotation 1.23 1 3.15 Surface-mount type 2 Center of stem rotation 1.23 Snap-in type 3

4

Thickness of the printed wiring boards in Figures 1 and 3 is 1.6mm.

Circuit Diagram

Surface-mount type



Center of stem rotation 1.23

Multi Control Devices

Variable Resistor Type

Switch Type

List of Varieties

	Se	ries				Switch type												
Item	s		SKQUAA/SKQUBA	SKQUCA	SKQUDB	SSAF	SRBE	SLLB	SLLB5 Small type									
ı	Photo					(a)												
Function				4-direction Center-Push		8-contact Free-direction Center-Push	Encoder & Push	Lever Return										
	Dimensions (typical value) D		– 10			10.85	8.05 11	11.8 11.4	9.5 8.8									
	m)	Н	7.1	7.1 10 8.6		3	3.17	3	2.2									
	Number of oper	rating shafts			I.	Single-shaft			I									
ds	Shaft ma					Resin												
Outlined specifica-tions	Directional r			4-direction		8-contact	_		ection									
Outlined cifica-ti	Directional opera Lever return n			With	;+h	Without	With Without		hout ith									
-tio	Center-				itn			With/	Ī									
ns	swit	ch		With/Without		W	ith	Without	With									
	Enco	der		With	nout		With	Wit	hout									
Operating	temperatu	re range		–30°C to +85°C			−10°C to	+60°C										
Auto	motive	use																
Rating (ma	ax.) (Resistiv	re load)	50mA 12V DC			20mA 5V DC	1mA 5V DC	10mA 5V DC										
Electrical performance	Outp volta					1V max. at 1mA 5V DC (Resistive		#55V Measuring \$5KΩ Measuring terminal										
cal	Directional resolution			4-direction		8-contact	_	2-dire	ection									
per	Insulation re	esistance	100M Ω min. 100V DC			10MΩ min. 100V DC	50MΩ min. 50V DC	100MΩ mi	n. 100V DC									
forr	Voltage	proof	250V AC for 1min.			100V AC for 1min.	50V AC for 1min.	100V AC	for 1min.									
nance	Directi opera forc	ting	1.57 ^{+0.49} _{-0.59} N 1.57 ^{+0.29} _{-0.89} N			0.5N ^{+0.5} _{-0.35} N		0.65±0.3N										
	Push operat	ting force		3.14±0.59N		2.5 ^{+0.7} _{-0.5} N	3.5±1.5N	2±1N	2.5±1N									
per	Encoder torq						3±2mN⋅m											
Mechanical performance	Term stren					3N for 1min.												
ical	Actuat	Pushing lirection				50N												
	or stre	perating direction				50N	10N											
E	Vibra	tion				amplitude is 1.5mm for all the frequencies, of X, Y and Z for 2 hours respectively												
Endurance	Operation Vithout	t load					0cycles											
	Operating life (at rated	l load)	.000			Г												
Enviro	Col			-30±2°C for 96h		-40±2℃		–20±2°Cfor 96h										
Environmenta performance	Dry h			80±2℃ for 96h		85±2℃ for 96h												
ntal	Damp		60±2°0	C, 90 to 95%RH f	for 96h		40±2℃, 90 to	95%RH for 96h										
Sol	Manual so	oldering	35	0°C max. 3s ma	ax.	350±10°C 4 ⁺ ∂s	3	50±5°C 3s ma	x.									
Soldering	Dip solo	dering	260°C max	. 5s max. (SKO	UAA,CA)	_												
ng	Reflow so	oldering	Please se	e P.495 (SKQL	JBA,DB)		Please s	ee P.495										
	Page			485		487	489	491	493									

Multi Control Devices

Variable Resistor Type

Switch Type

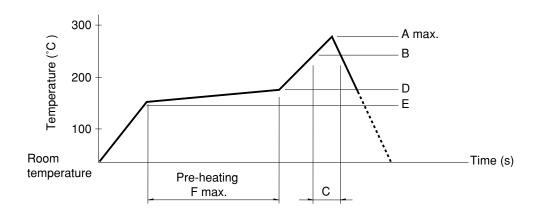
Switch Type Multi Control Devices Soldering Conditions
 Switch Type Multi Control Devices Cautions
 495

Soldering Conditions

Example of Reflow Soldering Condition

- 1. Heating method: Double heating method with infrared heater.
- 2. Temperature measurement: Thermocouple 0.1 to 0.2ϕ CA (K) or CC (T) at solder joints copper foil surface). A heat resistive tape should be used to fix thermocouple.
- 3. Temperature profile

Multi Control Devices



Series(Reflow type)	A (℃) 3s max.	B (℃)	C (s)	D (℃)	E (°C)	F(s)
RKJXS	260		40	150	150	120
SLLB, SLLB5	240	230	20	150		
SKRV/SKRH/SKQUBA,DB/SSAF/SRBE	260		40	180		

Variable Resistor Type

Switch Type

Notes

- 1. The above temperature shall be measured on the mounting surface of a PC board. There are cases where the PC board's temperature greatly differs from that of the switch, depending on the material, size thickness of PC boards and others. The above-stated conditions shall also apply to switch surface temperatures.
- 2. Soldering conditions differ depending on reflow soldering machines. Prior verification of soldering condition is highly recommended.